

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S49	102	"29"/\$ and mounting with (component ic chip semiconductor substrate board) and light near2 (source path) and (vacuum suck\$3 suction) near2 (chuck head nozzle)	USPAT; EPO; JPO	OR	ON	2005/05/17 16:07
S50	21	"294"/\$ and mounting with (component ic chip semiconductor substrate board) and light near2 (source path) and (vacuum suck\$3 suction) near2 (chuck head nozzle)	USPAT; EPO; JPO	OR	ON	2005/05/17 16:09
S51	95	"356"/\$ and mounting with (component ic chip semiconductor substrate board) and light near2 (source path) and (vacuum suck\$3 suction) near2 (chuck head nozzle)	USPAT; EPO; JPO	OR	ON	2005/05/17 16:20
S52	21	"228"/\$ and mounting with (component ic chip semiconductor substrate board) and light near2 (source path) and (vacuum suck\$3 suction) near2 (chuck head nozzle)	USPAT; EPO; JPO	OR	ON	2005/05/17 16:24
S53	8	("5257714").URPN.	USPAT	OR	ON	2005/05/17 16:21
S54	10	("3641648"   "3713575"   "4604648"   "4675993"   "4677473"   "4728195"   "4813588"   "4848639"   "4970380"   "5033665").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/05/17 16:22
S55	15	("5044072").URPN.	USPAT	OR	ON	2005/05/17 16:22
S56	24	"901"/\$ and mounting with (component ic chip semiconductor substrate board) and light near2 (source path) and (vacuum suck\$3 suction) near2 (chuck head nozzle)	USPAT; EPO; JPO	OR	ON	2005/05/17 16:27
S57	6	("4793707"   "5012115"   "5131139"   "5224262"   "5471310"   "6292261").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/05/17 16:24
S58	4	"174"/\$ and mounting with (component ic chip semiconductor substrate board) and light near2 (source path) and (vacuum suck\$3 suction) near2 (chuck head nozzle)	USPAT; EPO; JPO	OR	ON	2005/05/17 16:27
S59	10	"361"/\$ and mounting with (component ic chip semiconductor substrate board) and light near2 (source path) and (vacuum suck\$3 suction) near2 (chuck head nozzle)	USPAT; EPO; JPO	OR	ON	2005/05/17 16:29

S60	97	(bonding mounting) near4 (head unit) with (component ic chip semiconductor substrate board) and light near2 (source path) and (vacuum suck\$3 suction) near2 (chuck head nozzle)	USPAT; EPO; JPO	OR	ON	2005/05/17 16:37
S61	6	("5359203").URPN.	USPAT	OR	ON	2005/05/17 16:35
S62	5	(bonding mounting) near4 (head unit) and (flex\$5 lead trace pad terminal) near4 (component substrate board) and light near2 (source path) with (vacuum suck\$3 suction) near2 (chuck head nozzle)	USPAT; EPO; JPO	OR	ON	2005/05/17 16:40
S63	3	29/833 and (bonding mounting) near4 (head unit) and light near2 (source path) with (vacuum suck\$3 suction) near2 (chuck head nozzle)	USPAT; EPO; JPO	OR	ON	2005/05/17 16:41
S64	4	29/833 and (bonding mounting) and light near2 (source path) with (vacuum suck\$3 suction) near2 (chuck head nozzle)	USPAT; EPO; JPO	OR	ON	2005/05/17 16:41
S65	2	29/832 and (bonding mounting) and light near2 (source path) with (vacuum suck\$3 suction) near2 (chuck head nozzle)	USPAT; EPO; JPO	OR	ON	2005/05/17 16:41
S66	0	29/832.ccls. and (bonding mounting) and light near2 (source path) with (vacuum suck\$3 suction) near2 (chuck head nozzle)	USPAT; EPO; JPO	OR	ON	2005/05/17 16:41
S67	2	29/720 and (bonding mounting) and light near2 (source path) with (vacuum suck\$3 suction) near2 (chuck head nozzle)	USPAT; EPO; JPO	OR	ON	2005/05/17 16:42
S68	9	29/721 and (bonding mounting) and light near2 (source path) with (vacuum suck\$3 suction) near2 (chuck head nozzle)	USPAT; EPO; JPO	OR	ON	2005/05/17 16:43
S69	0	29/738 and (bonding mounting) and light near2 (source path) with (vacuum suck\$3 suction) near2 (chuck head nozzle)	USPAT; EPO; JPO	OR	ON	2005/05/17 16:43
S70	2	29/741 and (bonding mounting) and light near2 (source path) with (vacuum suck\$3 suction) near2 (chuck head nozzle)	USPAT; EPO; JPO	OR	ON	2005/05/17 16:44
S71	5	29/743 and (bonding mounting) and light near2 (source path) with (vacuum suck\$3 suction) near2 (chuck head nozzle)	USPAT; EPO; JPO	OR	ON	2005/05/17 16:44

S72	3	"294"/\$ and (bonding mounting) and light near2 (source path) with (vacuum suck\$3 suction) near2 (chuck head nozzle)	USPAT; EPO; JPO	OR	ON	2005/05/17 16:45
S73	21	"356"/\$ and (bonding mounting) and light near2 (source path) with (vacuum suck\$3 suction) near2 (chuck head nozzle)	USPAT; EPO; JPO	OR	ON	2005/05/17 16:46
S74	3	"228"/\$ and (bonding mounting) and light near2 (source path) with (vacuum suck\$3 suction) near2 (chuck head nozzle)	USPAT; EPO; JPO	OR	ON	2005/05/17 16:47
S75	4	"901"/\$ and (bonding mounting) and light near2 (source path) with (vacuum suck\$3 suction)-near2 (chuck head nozzle)	USPAT; EPO; JPO	OR	ON	2005/05/17 17:42
S76	46	(bond\$3 mount\$3) with (substrate board lead\$1frame) and light near2 (source path) same (vacuum suck\$3 suction) near2 (chuck head nozzle) and camera	USPAT; EPO; JPO	OR	ON	2005/06/02 16:48
S77	3	(bond\$3 mount\$3) with (lcd lpd acf tft tcp) and light near2 (source path) same (vacuum suck\$3 suction) near2 (chuck head nozzle) and camera	USPAT; EPO; JPO	OR	ON	2005/05/17 17:48
S78	7	("4943732").URPN.	USPAT	OR	ON	2005/05/17 17:49
S79	8	("5501004").URPN.	USPAT	OR	ON	2005/05/17 17:49
S80	24	("3648354"   "3962714"   "4569574"   "4634227"   "4648686"   "4703559"   "4802744"   "4950527"   "4964700"   "5074648"   "5288006"   "5398863"   "5489749"   "5501004"   "5506919"   "5523920"   "5653017"   "5698068"   "5743459"   "5943217"   "6023075"   "6094294"   "6104462"   "6195139").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/05/17 17:50
S81	20	("4964700").URPN.	USPAT	OR	ON	2005/05/17 17:52
S82	8	("5501004").URPN.	USPAT	OR	ON	2005/05/17 17:54
S83	10	("4393579"   "4480780"   "4796357"   "4868973"   "4876791"   "4956911"   "5207467"   "5501004"   "5591295"   "5628660").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/05/17 17:55

S84	24	("3648354"   "3962714"   "4569574"   "4634227"   "4648686"   "4703559"   "4802744"   "4950527"   "4964700"   "5074648"   "5288006"   "5398863"   "5489749"   "5501004"   "5506919"   "5523920"   "5653017"   "5698068"   "5743459"   "5943217"   "6023075"   "6094294"   "6104462"   "6195139").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/05/17 17:56
S85	5	("6089442").URPN.	USPAT	OR	ON	2005/05/17 17:57
S86	8	("5501004").URPN.	USPAT	OR	ON	2005/05/17 17:58
S87	5	("3774834"   "3949925"   "4967261"   "5177596"   "5276961").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/05/17 17:58
S88	7	("4943732").URPN.	USPAT	OR	ON	2005/05/17 18:03
S89	17	light near2 (source path) same (vacuum suck\$3 suction) near2 (chuck head nozzle) with (reference mark)	USPAT; EPO; JPO	OR	ON	2005/06/02 16:51
S90	9	light near2 (source path) and (vacuum suck\$3 suction) near2 (chuck head nozzle) with (reference mark) near3 (component ic chip ec)	USPAT; EPO; JPO	OR	ON	2005/06/02 16:51